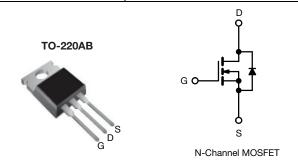
Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	1000				
$R_{DS(on)}(\Omega)$	V _{GS} = 10 V 11				
Q _g max. (nC)	38				
Q _{gs} (nC)	4.9				
Q _{gd} (nC)	22				
Configuration	Single				



FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- · Fast switching
- · Ease of paralleling
- Simple drive requirements
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Load (Db) from	IRFBG20PbF		
Lead (Pb)-free	SiHFBG20-E3		
SnPb	IRFBG20		
SIPD	SiHFBG20		

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	1000		
Gate-Source Voltage			V_{GS}	± 20	- V	
Continuous Drain Current	V -140.V	T _C = 25 °C		1.4		
Continuous Drain Current	V _{GS} at 10 V	T _C = 100 °C	I _D	0.86	Α	
Pulsed Drain Current ^a			I _{DM}	5.6	1	
Linear Derating Factor				0.43	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	200	mJ	
Repetitive Avalanche Current ^a			I _{AR}	1.4	А	
Repetitive Avalanche Energy ^a			E _{AR}	5.4	mJ	
Maximum Power Dissipation $T_C = 25 ^{\circ}C$			P_{D}	54	W	
Peak Diode Recovery dV/dt ^c			dV/dt	1.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Soldering Recommendations (Peak temperature) d for 10 s				300	7	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
Mounting Torque			Ţ	1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD}=50$ V, starting $T_J=25$ °C, L=193 $\mu H,$ $R_g=25$ $\Omega,$ $I_{AS}=1.4$ A (see fig. 12). c. $I_{SD}\leq 1.4$ A, $dI/dt\leq 60$ A/ μ s, $V_{DD}\leq 600$, $T_J\leq 150$ °C. d. 1.6 mm from case.

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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	62			
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	=	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	2.3			

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		•		l	l .	•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		1000	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 1 mA		1.2	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zoro Goto Voltago Drain Current	I	V _{DS} = 1000 V, V _{GS} = 0 V		-	-	100	μA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 800 \text{ V}$	$V_{1}, V_{GS} = 0 V, T_{J} = 125 ^{\circ}C$	-	-	500	μΑ
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 0.84 A ^b	-	-	11	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	50 V, I _D = 0.84 A ^b	1.0	-	-	S
Dynamic							
Input Capacitance	C_{iss}		$V_{GS} = 0 V$	-	500	-	рF
Output Capacitance	C_{oss}		$V_{DS} = 25 \text{ V},$	-	52	-	
Reverse Transfer Capacitance	C_{rss}	t = 1.	f = 1.0 MHz, see fig. 5		17	-	
Total Gate Charge	Q_g		I _D = 1.4 A, V _{DS} = 400 V, see fig. 6 and 13 ^b	-	-	38	nC
Gate-Source Charge	Q_{gs}	V _{GS} = 10 V		-	-	4.9	
Gate-Drain Charge	Q_{gd}			-	-	22	
Turn-On Delay Time	t _{d(on)}		V_{DD} = 500 V, I_D = 1.4 A, R_g = 18 Ω , R_D = 370 Ω , see fig. 10 ^b		9.4	-	- ns
Rise Time	t _r				17	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 18 \Omega$, I			58	-	
Fall Time	t _f	1		-	31	-	
Internal Drain Inductance	L_D	6 mm (0.25") t	Between lead, 6 mm (0.25") from package and center of die contact		4.5	-	ъЦ
Internal Source Inductance	L _S				7.5	-	- nH
Gate Input Resistance	R _g	f = 1 MHz, open drain		0.6	-	3.4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	MOSFET sym showing the	MOSFET symbol showing the		-	1.4	^
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	5.6	A
Body Diode Voltage	V _{SD}	T _J = 25 °C	T _J = 25 °C, I _S = 1.4 A, V _{GS} = 0 V b		-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 ^{\circ}\text{C}, \ I_F = 1.4 \text{A}, \ \text{dI/dt} = 100 \text{A/}\mu\text{s}^{ \text{b}}$		-	130	190	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.46	0.69	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s$; duty cycle $\leq 2~\%$.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

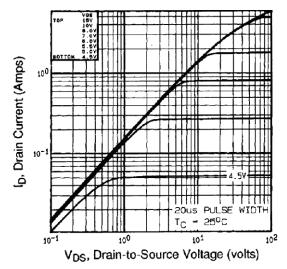


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

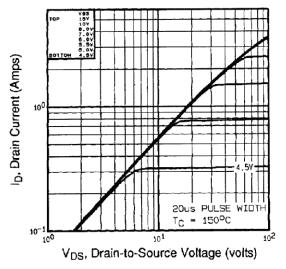


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

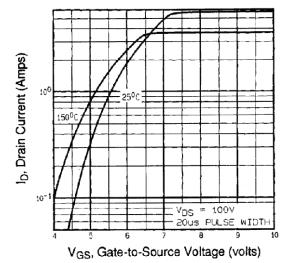


Fig. 3 - Typical Transfer Characteristics

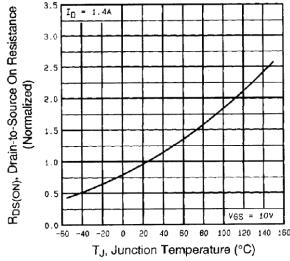


Fig. 4 - Normalized On-Resistance vs. Temperature



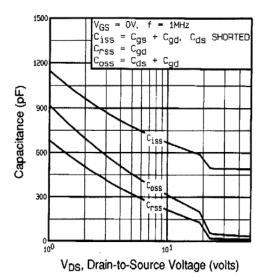


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

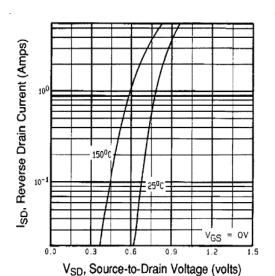


Fig. 7 - Typical Source-Drain Diode Forward Voltage

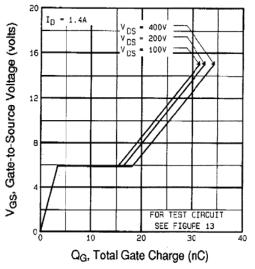


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

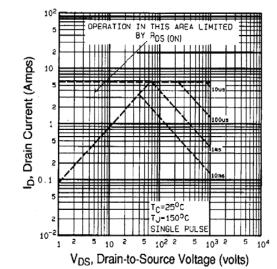


Fig. 8 - Maximum Safe Operating Area



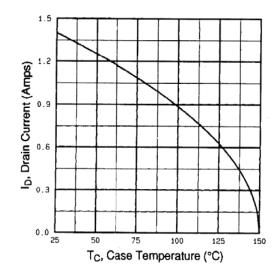


Fig. 9 - Maximum Drain Current vs. Case Temperature

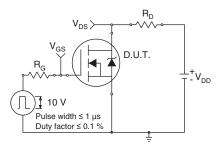


Fig. 10a - Switching Time Test Circuit

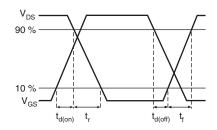


Fig. 10b - Switching Time Waveforms

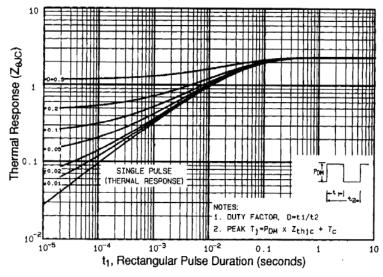


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

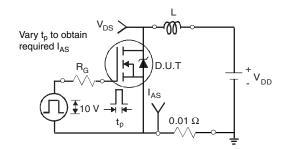


Fig. 12a - Unclamped Inductive Test Circuit

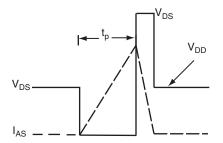


Fig. 12b - Unclamped Inductive Waveforms



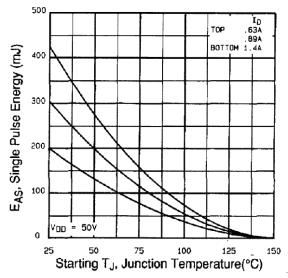


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

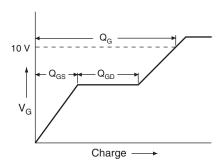


Fig. 13a - Basic Gate Charge Waveform

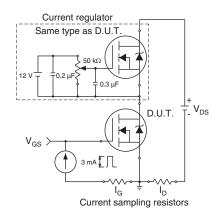
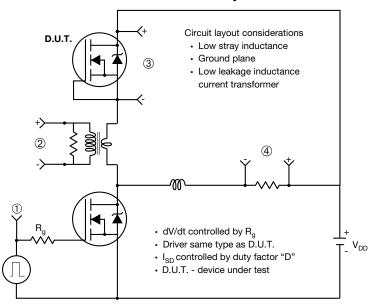


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



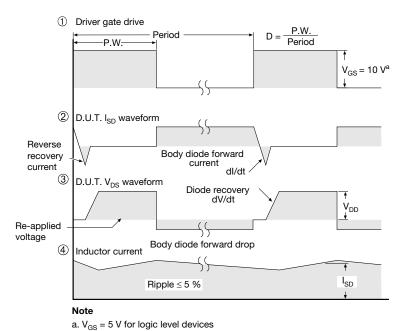
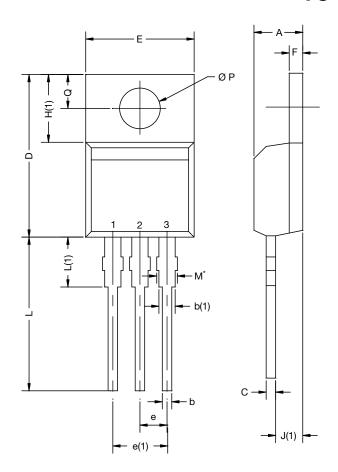


Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91123.



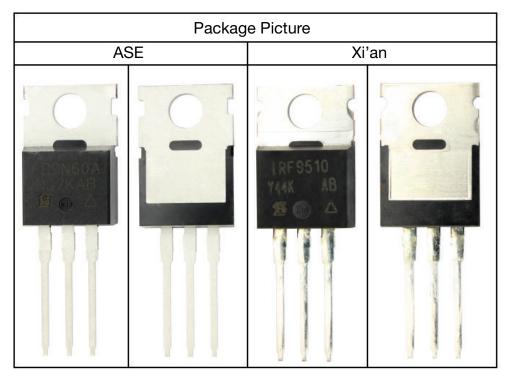
TO-220-1



DIM.	MILLIM	IETERS	INCHES			
DIM.	MIN.	MAX.	MIN.	MAX.		
Α	4.24	4.65	0.167	0.183		
b	0.69	1.02	0.027	0.040		
b(1)	1.14	1.78	0.045	0.070		
С	0.36	0.61	0.014	0.024		
D	14.33	15.85	0.564	0.624		
Е	9.96	10.52	0.392	0.414		
е	2.41	2.67	0.095	0.105		
e(1)	4.88	5.28	0.192	0.208		
F	1.14	1.40	0.045	0.055		
H(1)	6.10	6.71	0.240	0.264		
J(1)	2.41	2.92	0.095	0.115		
L	13.36	14.40	0.526	0.567		
L(1)	3.33	4.04	0.131	0.159		
ØР	3.53	3.94	0.139	0.155		
Q	2.54	3.00	0.100	0.118		
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031						

Note

 M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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